Docket No. TRANSMITTAL LETTER JUL 1 9 2004 CA920020078US1 (General - Patent Pending) In Re Application Of: Brouillette, et al. **Group Art Unit Examiner Filing Date** Serial No. 03-Dec-2003 10/707,293 Unassigned Unassigned Method and Apparatus for Transferring Solder Bumps Title: TO THE DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE: Transmitted herewith is: 1. Certified copy of foreign patent application (Canadian Patent Serial #2,426,651) 2. Return Postcard in the above identified application. No additional fee is required. as described below. A De la grande de la constanta de la companya de l La companya de la co □ .... Charge the amount of the state of th Credit any overpayment. Charge any additional fee required. X Dated: 7/14/2004Robert A. Walch Signature Robert A. Walsh, Reg. No. 26,516 IP Law Department, 972E **IBM Corporation** certify that this document and fee is being deposited on 1000 River Street with the U.S. Postal Service as first Essex Junction, VT 05452 class mail under 37 C.F.R. 1.8 and is addressed to the Director of the United States Patent and Trademark Office, Tel. No. 802-769-9521 P.O. Box 1450, Alexandria, VA 2231,3-1450.

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## THE UNITED STATES PATENT AND TRADEMARK OFFICE PATENT APPLICATION

Applicant:

Brouillette et al.

Art Unit:

Serial No.:

10/707293

Examiner:

Filed:

12/03/2003

Atty. Docket:

CA9-2002-0087

Title:

METHOD AND APPARATUS FOR TRANSFERRING SOLDER BUMPS.

Honorable Commissioner of Patents and Trademarks Washington, D.C. 20231

Sir:

Applicants are hereby submitting certified copies of the foreign application, Canadian Application for Patent Serial No: 2,426,651 filed on April 28, 2003 as specified in 35 U.S.C. § 119(b).

Respectfully submitted,

Robert A. Walsh, Reg. No. 26,516

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## CERTIFICATE OF MAILING OR FAXING

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